

HT82V733 240mA Audio Power Amp

Features

- High signal-to-noise ratio
- · High slew rate
- · Low distortion
- · Large output voltage swing
- · Excellent power supply ripple rejection
- · Low power consumption
- · Short-circuit elimination

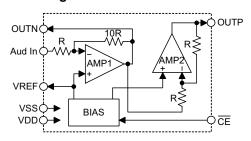
- · Wide temperature operating range
- · No switch ON/OFF clicks
- Low standby current
- · Power off control
- · Direct drive speaker
- · 8-pin DIP/SOP package

General Description

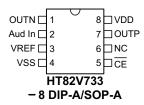
HT82V733 is an integrated class AB mono speaker driver contained in an SOP-8 package. The device is

fabricated in a CMOS process and has been primarily developed for portable digital audio applications.

Block Diagram



Pin Assignment



Pin Description

| Pin No. | Pin Name | I/O | Description | |
|---------|----------|-----|---|--|
| 1 | OUTN | 0 | Negative output | |
| 2 | Aud In | I | Audio input | |
| 3 | VREF | 0 | Speaker non-inverting input voltage reference | |
| 4 | VSS | _ | Negative power supply, ground | |
| 5 | CE | ı | Chip enable, low active | |
| 6 | NC | _ | Not connected | |
| 7 | OUTP | 0 | Positive output | |
| 8 | VDD | _ | Positive power supply | |

Absolute Maximum Ratings

| Supply VoltageV _{SS} -0.3V to V _{SS} +5.5V | Storage Temperature50°C to 125°C |
|--|-----------------------------------|
| Input VoltageV _{SS} -0.3V to V _{DD} +0.3V | Operating Temperature20°C to 70°C |

Note: These are stress ratings only. Stresses exceeding the range specified under "Absolute Maximum Ratings" may cause substantial damage to the device. Functional operation of this device at other conditions beyond those listed in the specification is not implied and prolonged exposure to extreme conditions may affect device reliability.



Electrical Characteristics

V_{SS}=0V, Ta=25°C

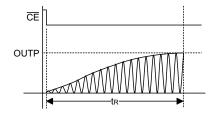
| Comple al | Damanastan | | Test Conditions | Min. | Тур. | Max. | Unit | |
|------------------|--|----------|--|---------|------|------|------|--|
| Symbol | Parameter | V_{DD} | Conditions | - Wiin. | | | | |
| Supplies | | | | | | | | |
| V _{DD} | Supply Voltage | _ | _ | 2.4 | 5.0 | 5.5 | V | |
| V _{SS} | Negative Supply Voltage | 5V | _ | _ | 0 | _ | V | |
| I _{STB} | Standby Current | _ | _ | _ | _ | 1 | μА | |
| | | | V _i =0, No load | 2 | 4 | 10 | mA | |
| I _{DD} | Operating Current | - | V _{P-P} =500mV, f _i =1kHz No load | 4.8 | 12.3 | 23.5 | | |
| P _{tot} | Total Power Dissipation | | V _{P-P} =500mV, f _i =1kHz No load | 15 | 60 | 140 | mW | |
| DC Charac | teristics | | | | | | | |
| V | 1 10" 111" | 5V | | _ 12 | | _ | | |
| $V_{I(OS)}$ | Input Offset Voltage | 3V | _ | _ | 2.5 | _ | mV | |
| | Maximum Output Current (THD+N)/S<1% | 5V | Current | _ | 240 | _ | | |
| l _O | | 3V | Current | _ | 160 | _ | mA | |
| | Output Voltage Swing (THD+N)/S<1% | | R _L =16Ω | 1.2 | _ | 4 | V | |
| | | 5V | R _L =8Ω | 1.8 | _ | 3.4 | | |
| \ / | | | $R_L=4\Omega$ | 2.1 | _ | 3 | | |
| V _O | | 3V | R _L =16Ω | 0.6 | _ | 2.3 | V | |
| | | | R _L =8Ω | 0.9 | _ | 1.9 | | |
| | | | $R_L=4\Omega$ | 1.1 | _ | 1.7 | | |
| | D 0 1 D : " D " | 5V | f _i =100Hz; | _ | 71 | _ | -10 | |
| PSRR | Power Supply Rejection Ratio | 3V | V _{ripple(p-p)} =100mV | _ | 62 | _ | dB | |
| AC Charac | teristics | • | | | | | | |
| (THD+N)/S | | 5V | V _{O(p-p)} =3.5V R _L =8Ω | | -48 | | dB | |
| | Total Harmonic Distortion Plus Noise-to-signal Ratio | οv | | | 3 | | % | |
| | | 3V | V _{O(p-p)} =1.5V | | -30 | _ | dB | |
| | | | $R_L=8\Omega$ | _ | 3 | _ | % | |
| 0/N | O'ment to make 5 # | 5V | | _ | 60 | _ | .15 | |
| S/N | Signal-to-noise Ratio | 3V | _ | _ | 58 | _ | dB | |



Functional Description

OUTP Rising Time (t_R)

When $\overline{\text{CE}}$ active low, the HT82V733 need rising time to output fully on OUTP pin. However, the rising time depends on C1. (*see the application circuits)



| Capacitor t _R | 0.1 μF | 1μF | 4.7 μ F | 10 μF |
|--------------------------|---------------|------|-----------------------|--------------|
| 2.2V | 15ms | 30ms | 90ms | 185ms |
| 3V | 15ms | 30ms | 90ms | 185ms |
| 4V | 15ms | 30ms | 90ms | 185ms |

For battery based applications, power consumption is a key issue, therefore the amplifier should be turned off when in the standby state. In order to eliminate any speaker sound bursts while turning the amplifier on, the application circuit, which will incorporate a capacitance value of C1, should be adjusted in accordance with the speaker s audio frequency response. A greater value of C1 will improve the noise burst while turning on the amplifier. The recommended operation sequence is:

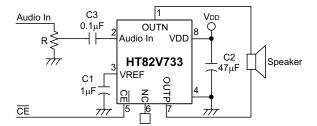
Turn On: audio1 signal standby (1/2 VDD) \rightarrow enable amplifier \rightarrow wait t_R for amplifier ready \rightarrow audio1 output

Turn Off: audio1 signal finished \rightarrow disable amplifier \rightarrow wait t_R for amplifier off \rightarrow audio1 signal off



If the application is not powered by batteries and there is no problem with amplifier On/Off issue, a capacitor value of 0.1uF for C1 is recommended.

Application Circuits





Package Information

8-pin DIP (300mil) Outline Dimensions



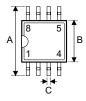




| Cumhal | Dimensions in mil | | | |
|--------|-------------------|------|------|--|
| Symbol | Min. | Nom. | Max. | |
| Α | 355 | _ | 375 | |
| В | 240 | _ | 260 | |
| С | 125 | _ | 135 | |
| D | 125 | _ | 145 | |
| E | 16 | _ | 20 | |
| F | 50 | _ | 70 | |
| G | _ | 100 | _ | |
| Н | 295 | _ | 315 | |
| I | 335 | _ | 375 | |
| α | 0° | _ | 15° | |



8-pin SOP (150mil) Outline Dimensions





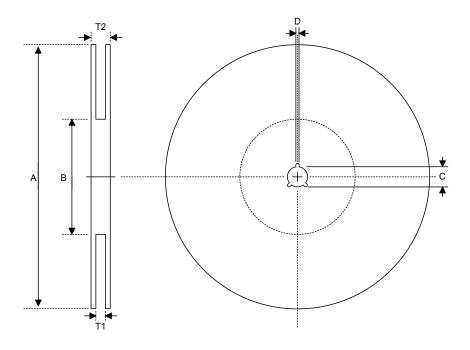


| Cumbal | Dimensions in mil | | | | |
|--------|-------------------|------|------|--|--|
| Symbol | Min. | Nom. | Max. | | |
| Α | 228 | _ | 244 | | |
| В | 149 | _ | 157 | | |
| С | 14 | _ | 20 | | |
| C' | 189 | _ | 197 | | |
| D | 53 | _ | 69 | | |
| E | _ | 50 | _ | | |
| F | 4 | _ | 10 | | |
| G | 22 | _ | 28 | | |
| Н | 4 | _ | 12 | | |
| α | 0° | _ | 10° | | |



Product Tape and Reel Specifications

Reel Dimensions

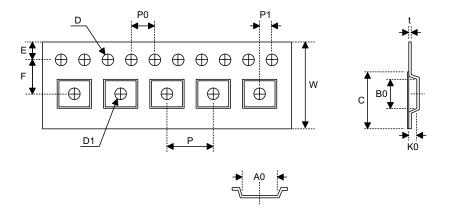


SOP 8N

| Symbol | Description | Dimensions in mm |
|--------|-----------------------|------------------|
| Α | Reel Outer Diameter | 330±1.0 |
| В | Reel Inner Diameter | 62±1.5 |
| С | Spindle Hole Diameter | 13.0+0.5 -0.2 |
| D | Key Slit Width | 2.0±0.15 |
| T1 | Space Between Flange | 12.8+0.3 -0.2 |
| T2 | Reel Thickness | 18.2±0.2 |



Carrier Tape Dimensions



SOP 8N

| Symbol | Description | Dimensions in mm |
|--------|--|------------------|
| W | Carrier Tape Width | 12.0+0.3 -0.1 |
| Р | Cavity Pitch | 8.0±0.1 |
| Е | Perforation Position | 1.75±0.1 |
| F | Cavity to Perforation (Width Direction) | 5.5±0.1 |
| D | Perforation Diameter | 1.55±0.1 |
| D1 | Cavity Hole Diameter | 1.5+0.25 |
| P0 | Perforation Pitch | 4.0±0.1 |
| P1 | Cavity to Perforation (Length Direction) | 2.0±0.1 |
| A0 | Cavity Length | 6.4±0.1 |
| В0 | Cavity Width | 5.20±0.1 |
| K0 | Cavity Depth | 2.1±0.1 |
| t | Carrier Tape Thickness | 0.3±0.05 |
| С | Cover Tape Width | 9.3 |



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